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To the Honorable Commissioner of Patents &

Please record the attached original documents or copy thereof.

1. Name of conveying party(ies)

Gabriele NELLES, Akio YASUDA, Stephane GAERING, Hans-Werner
SCHMIDT, Mukundan THELAKKAT, K.R. HARIDASAdditional name(s) of conveying party(ies) attached?
☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: SONY International (Europe) GmbH
Kemperplatz 1
D-10785 Berlin
GERMANYAdditional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment
☐ Security Agreement
☐ Merger
☐ Change of Name
☐ OtherExecution Date(s): August 26, August 26, October 14,
September 4, September 4 and October 8, 2002

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of
the application is:A. Patent Application No.(s) 10/234,543 filed September 3, 2002Additional numbers attached? ☐ Yes ☒ NoFINANCE SECTION
NOV 11 11:56
RECORDS5. Name and address of party to whom correspondence
concerning document should be mailed:

Name: WILLIAM S. FROMMER

Internal Address: FROMMER LAWRENCE & HAUG LLP

Street Address: 745 FIFTH AVENUE

City: NEW YORK State: N.Y. Zip: 10151

6. Total number of applications and
patents involved

1

7. Total fee (37 CFR 3.41) \$ 40.00
☒ Enclosed
☐ Authorized to be charged to
deposit account 50-0320

8. Deposit account number:

(Attach duplicate copy of this page if paying by deposit
account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true
copy of the original document.

GORDON KESSLER

Name of Person Signing

Signature

November 22, 2002

Date

Total number of pages including cover
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PK2-1000C, Washington, D.C. 20231, and to the Office of Management and Budget, Paperwork Reduction Project (0651-0011),
Washington, D.C. 20503.

WHEREAS, I, as below named inventors, residing at the addresses stated next to our names, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, SONY International (Europe) GmbH, a German corporation, with offices at Kemperplatz 1, D-10785 Berlin, GERMANY (hereinafter referred to as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: _____, Filing Date: ____.

This assignment executed on the dates indicated below.

10/234,543

September 3, 2002

Gabriele NELLES

Name of first or sole inventor

Execution date of U.S. Patent Application

Stuttgart, Germany

Residence of first or sole inventor

Signature of first or sole inventor

Date of this assignment

Akio YASUDA

Name of second inventor

Execution date of U.S. Patent Application

Stuttgart, Germany

Residence of second inventor

Signature of second inventor

Date of this assignment

Stephane GAERING

Name of third inventor

Execution date of U.S. Patent Application

Buhl, France

Residence of third inventor

Signature of third inventor

Date of this assignment

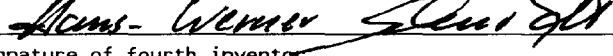
Hans-Werner SCHMIDT

Name of fourth inventor

Execution date of U.S. Patent Application

Bayreuth, Germany

Residence of fourth inventor



September 4, 2002

Signature of fourth inventor

Date of this assignment

Mukundan THELAKKAT

Name of fifth inventor

Execution date of U.S. Patent Application

Bayreuth, Germany

Residence of fifth inventor



04.09.2002.

Signature of fifth inventor

Date of this assignment

K.R. HARIDAS

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Execution date of U.S. Patent Application

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Residence of sixth inventor

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06-10-2002
Date of this assignment